

美国OK APR-5000 系列芯片转移工具

产品名称	美国OK APR-5000 系列芯片转移工具
公司名称	上海艾田电子科技有限公司
价格	.00/个
规格参数	品牌:美国OK 型号:APR-5000DT
公司地址	上海市嘉定区真新街道金沙江路3131号5幢J1409室（注册地址）
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产品详情

品牌 美国OK 型号 APR-5000DT
详细内容

dip transfer

this process involves dipping a component into gel flux, depositing an exact amount of flux. this process is quick, consistent, and negates the need to clean after reflow. available for both solder balled and leaded devices. all kits are supplied with a metal

dip transfer accessories

part no.	array package
dtp-bga	set of 3 plates, apertures 28, 35 & 45mm, depth 0.012" (0.30mm)
dtp-csp	set of 3 plates, apertures 10, 16, & 21mm, depth 0.006" (0.15mm)
dtbk-usmd	kit, usmd flux transfer blocks, set of 2 blocks, depth 0.003" (0.08mm) and 0.004" (0.10mm)
dtbk-fc	kit, flip chip flux transfer blocks, set of 2 blocks, depth 0.001" (0.025mm) and 0.

